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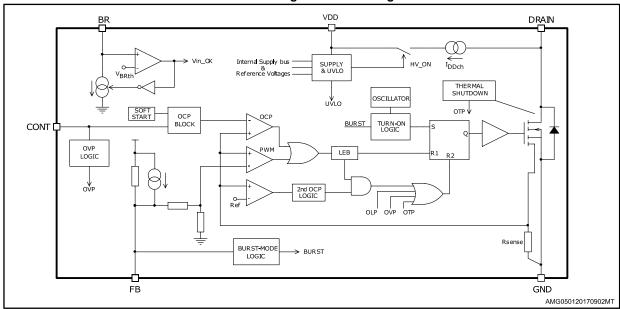


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VIPER17 Block diagram

1 Block diagram

Figure 2: Block diagram



2 Typical power

Table 2: Typical power

Part number	230 V _{AC}		85-265 V _{AC}		
Part number	Adapter (1)	Open frame (2)	Adapter (1)	Open frame (2)	
	9 W	10 W	5 W	6 W	

Notes:

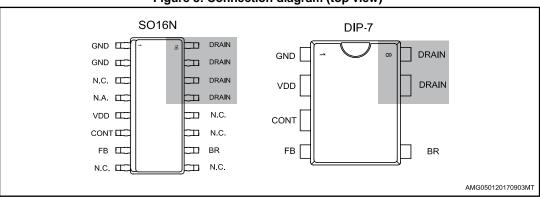
 $^{^{(1)}}$ Typical continuous power in non ventilated enclosed adapter measured at 50 $^{\circ}$ C ambient.

⁽²⁾Maximum practical continuous power in an open frame design at 50 °C ambient, with adequate heat sinking.

Pin settings VIPER17

3 Pin settings

Figure 3: Connection diagram (top view)





The copper area for heat dissipation has to be designed under the DRAIN pins.

Table 3: Pin description

Pin n.		Name	Function
DIP-7	SO16	Name	Function
1	12	GND	This pin represents the device ground and the source of the power section.
-	4	N.A.	Not available for user. This pin is mechanically connected to the controller die pad of the frame. In order to improve the noise immunity, is highly recommended connect it to GND (pin 1-2).
2	5	VDD	Supply voltage of the control section. This pin also provides the charging current of the external capacitor during startup time.
3	6	CONT	Control pin. The following functions can be selected: 1. current limit set point adjustment. The internal set default value of the cycle-by-cycle current limit can be reduced by connecting to ground an external resistor. 2. output voltage monitoring. A voltage exceeding VovP threshold (see Table 8: "Controller section") shuts the IC down reducing the device consumption. This function is strobed and digitally filtered for high noise immunity.
4	7	FB	Control input for duty cycle control. Internal current generator provides bias current for loop regulation. A voltage below the threshold V _{FBbm} activates the burst-mode operation. A level close to the threshold V _{FBlin} means that we are approaching the cycle-by-cycle over-current set point.
Brownout protection input with hyster V _{BRth} shuts down (not latch) the device 5 10 BR consumption. Device operation restated threshold V _{BRth} + V _{BRhyst} .		BR	Brownout protection input with hysteresis. A voltage below the threshold V _{BRth} shuts down (not latch) the device and lowers the power consumption. Device operation restarts as the voltage exceeds the threshold V _{BRth} + V _{BRhyst} . It can be connected to ground when not used.
7,8	13-16	DRAIN	High voltage drain pin. The built-in high voltage switched startup bias current is drawn from this pin too. Pins connected to the metal frame to facilitate heat dissipation.

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VIPER17 Electrical data

4 Electrical data

4.1 Maximum ratings

Table 4: Absolute maximum ratings

Complete	D::: (DID 7)	Donomotor	,	Value	11	
Symbol	Pin (DIP-7)	Parameter	Min.	Max.	Unit	
V _{DRAIN}	7, 8	Drain-to-source (ground) voltage		800	V	
Eav	7, 8	Repetitive avalanche energy (limited by T _J = 150 °C)		2	mJ	
I _{AR}	7, 8	Repetitive avalanche current (limited by T _J = 150 °C)		1	А	
Idrain	7, 8	Pulse drain current		2.5	Α	
Vcont	3	Control input pin voltage (with I _{CONT} = 1 mA)	-0.3	Self limited	>	
V _{FB}	4	Feed-back voltage	-0.3	5.5	V	
V _{BR}	5	Brown-out input pin voltage (with I _{BR} = 0.5 mA)	-0.3	Self limited	V	
V _{DD}	2	Supply voltage (I _{DD} = 25 mA)	-0.3	Self limited	V	
I _{DD}	2	Input current		25	mA	
D		Power dissipation at T _A < 40 °C (DIP-7)		1	W	
Ртот		Power dissipation at T _A < 60 °C (SO16N)		1	W	
TJ		Operating junction temperature range	-40	150	°C	
T _{STG}		Storage temperature	-55	150	°C	
ESD _(HBM)	1 to 8	Human body model		4	kV	
ESD(CDM)	1 to 8	Charge device model		1.5	kV	

4.2 Thermal data

Table 5: Thermal data

Symbol	Parameter	Max. value SO16N	Max. value DIP-7	Unit
R _{thJP}	Thermal resistance junction pin (dissipated power = 1 W)	35	40	°C/W
R _{thJA}	Thermal resistance junction ambient (dissipated power = 1 W)	110	110	°C/W
R _{thJA}	Thermal resistance junction ambient (dissipated power = 1 W) (1)	80	90	°C/W

Notes:

 $^{^{(1)}}$ When mounted on a standard single side FR4 board with 100 mm² (0.155 sq in) of Cu (35 μ m thick).



Electrical data VIPER17

4.3 Electrical characteristics

 $(T_J = -25 \text{ to } 125 \text{ °C}, V_{DD} = 14 \text{ V})^a$

Table 6: Power section

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V _{BVDSS}	Break-down voltage	$I_{DRAIN} = 1 \text{ mA}$ $V_{FB} = GND$ $T_{J} = 25 \text{ °C}$	800			V
	OFF state dusin assurant	V _{DRAIN} = 640 V V _{FB} = GND			60	μΑ
loff	OFF state drain current	$V_{DRAIN} = 800 \text{ V}$ $V_{FB} = GND$			75	μΑ
		$I_{DRAIN} = 0.2 \text{ A},$ $V_{FB} = 3 \text{ V}$ $V_{BR} = \text{GND},$ $T_{J} = 25 \text{ °C}$		20	24	Ω
R _{DS(on)}	Drain-source on state resistance	I _{DRAIN} = 0.2 A V _{FB} = 3 V V _{BR} = GND T _J = 125 °C		40	48	Ω
Coss	Effective (energy related) output capacitance	V _{DRAIN} = 0 to 640 V		10		pF

Table 7: Supply section

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Voltage			·			
V _{DRAIN_START}	Drain-source start voltage		60	80	100	V
		$V_{DRAIN} = 120 \text{ V}$ $V_{BR} = GND$ $V_{FB} = GND$ $V_{DD} = 4 \text{ V}$	-2	-3	-4	mA
IDDch	Startup charging current	$V_{DRAIN} = 120 \text{ V}$ $V_{BR} = GND$ $V_{FB} = GND$ $V_{DD} = 4 \text{ V}$ after fault.	-0.4	-0.6	-0.8	mA
V_{DD}	Operating voltage range	After turn-on	8.5		23.5	V
$V_{DDclamp}$	V _{DD} clamp voltage	I _{DD} = 20 mA	23.5			V
V_{DDon}	V _{DD} startup threshold	V _{DRAIN} = 120 V	13	14	15	V
V_{DDoff}	V _{DD} under voltage shutdown threshold	V _{BR} = GND V _{FB} = GND	7.5	8	8.5	V
VDD(RESTART)	V _{DD} restart voltage threshold	$V_{DRAIN} = 120 \text{ V}$ $V_{BR} = GND$ $V_{FB} = GND$	4	4.5	5	V

 $^{^{\}rm a}$ Adjust V_{DD} above V_{DDon} startup threshold before settings to 14 V.

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VIPER17 Electrical data

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Current						
I _{DD0}	Operating supply current, not switching	$V_{FB} = GND$ $F_{SW} = 0 \text{ kHz}$ $V_{BR} = GND$, $V_{DD} = 10 \text{ V}$			0.9	mA
1	Operating supply current, switching	V _{DRAIN} = 120 V F _{SW} = 60 kHz			1.8	mA
I _{DD1}		V _{DRAIN} = 120 V F _{SW} = 115 kHz			2	mA
IDD_FAULT	Operating supply current, with protection tripping				400	μΑ
I _{DD_OFF}	Operating supply current with V _{DD} < V _{DD_off}	V _{DD} = 7 V			270	μΑ

Table 8: Controller section

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Feed-back p	pin		·			
V _{FBolp}	Overload shut down threshold		4.5	4.8	5.2	V
VFBlin	Linear dynamics upper limit		3.2	3.3	3.4	>
V _{FBbm}	Burst mode threshold	Voltage falling	0.4	0.45	0.6	V
V _{FBbmhys}	Burst mode hysteresis	Voltage rising		50		mV
I _{FB}	Feed-back sourced current	V _{FB} = 0.3 V	-150	-200	-280	uA
IFB	Feed-back sourced current	3.3 V < V _{FB} < 4.8 V		-3		uA
R _{FB(DYN)}	Dynamic resistance	V _{FB} < 3.3 V	12		19	kΩ
H _{FB}	ΔV _{FB} / ΔI _D		3		8	V/A
CONT pin		·	<u>.</u>			
VCONT_I	Low level clamp voltage	I _{CONT} = -100 μA		0.5		V
VCONT_h	High level clamp voltage	ICONT = 1 mA	5	5.5	6	V
Current limi	tation	·				
I _{Dlim}	Max drain current limitation (1)	V _{FB} = 4 V I _{CONT} = -10 μA T _J = 25 °C	0.38	0.4	0.42	А
tss	Soft-start time			8.5		ms
Ton_min	Minimum turn ON time		220	400	480	ns
td	Propagation delay	(2)		100		ns
t _{LEB}	Leading edge blanking	(2)		300		ns
I _{D_BM}	Peak drain current during burst mode	V _{FB} = 0.6 V		90		mA



Electrical data VIPER17

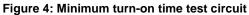
Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Oscillator s	ection					
	VIPER17L	V _{DD} = operating voltage range	54	60	66	kHz
Fosc	VIPER17H	V _{FB} = 1 V	103	115	127	kHz
	Madulation donth	VIPER17L		±4		kHz
FD	Modulation depth	VIPER17H		±8		kHz
FM	Modulation frequency			250		Hz
D _{MAX}	Maximum duty cycle		70		80	%
Overcurren	t protection (2 nd OCP)					
I _{DMAX}	Second over current threshold	(2)		0.6		Α
Overvoltage	protection					
Vovp	Overvoltage protection threshold		2.7	3	3.3	V
TSTROBE	Overvoltage protection strobe time			2.2		μs
Brown out	protection					
V_{BRth}	Brown out threshold	Voltage falling	0.41	0.45	0.49	V
V _{BRhyst}	Voltage hysteresis above V _{BRth}			50		mV
I _{BRhyst}	Current hysteresis		7		12	μA
V _{BRclamp}	Clamp voltage	I _{BR} = 250 μA		3		V
V _{DIS}	Brown out disable voltage		50		150	mV
Thermal sh	utdown					
T _{SD}	Thermal shutdown temperature	(2)	150	160		°C
T _{HYST}	Thermal shutdown hysteresis	(2)		30		°C

Notes:

 $^{^{(1)}}I_{Dlim}$ @ V_{DD} lower than 10 V can range between -5 % and +15 %.

⁽²⁾Specification assured by design, characterization and statistical correlation.

VIPER17 Electrical data



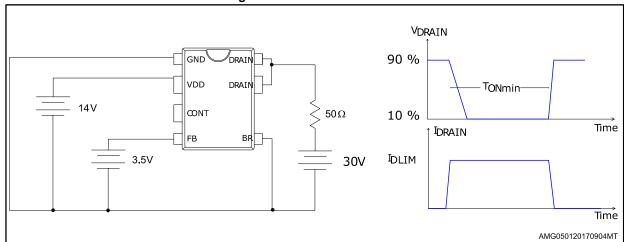


Figure 5: Brown out threshold test circuit

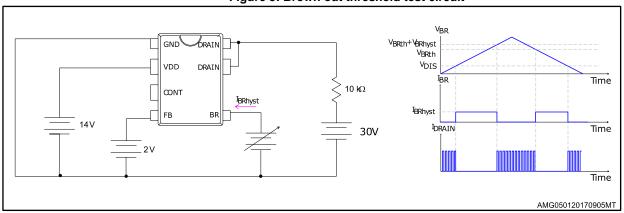
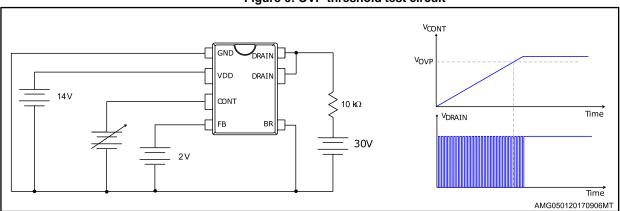


Figure 6: OVP threshold test circuit

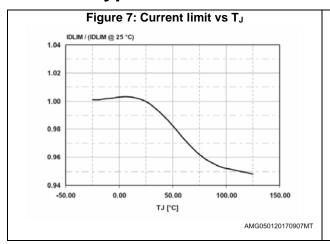


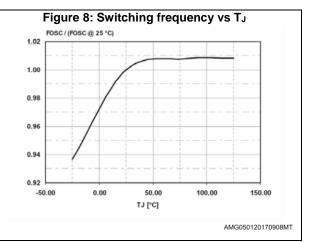


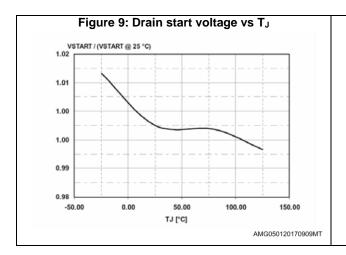
Adjust V_{DD} above V_{DDon} startup threshold before settings to 14 V.

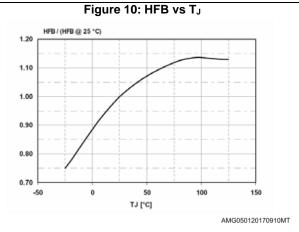


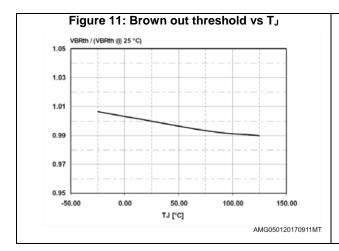
5 Typical electrical characteristics

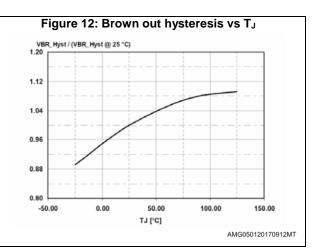












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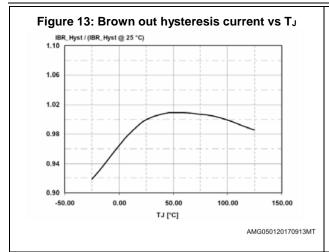


Figure 14: Operating supply current (no switching) vs T_J IDD0 / (IDD0 @ 25 °C) 1.06 1.04 1.01 0.99 0.96 0.94 -50.00 0.00 50.00 100.00 150.00 TJ [°C] AMG050120170914MT

Figure 15: Operating supply current (switching) vs T_J

1.06

1.04

1.01

0.99

0.94

-50.00

0.00

1.00

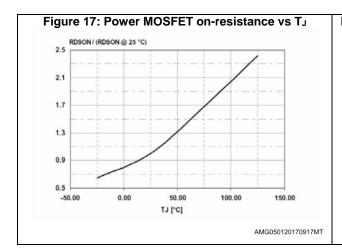
1.00

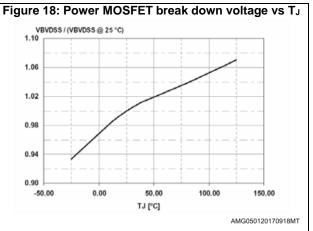
1.00

1.01

AMG050120170915MT

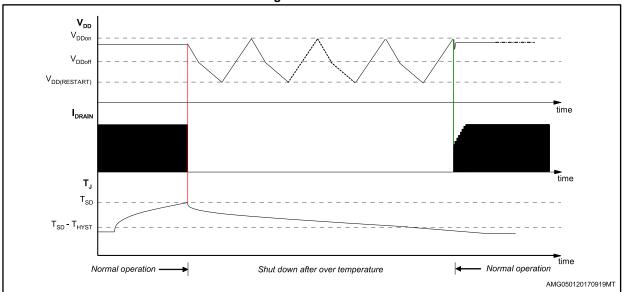






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Figure 19: Thermal shutdown



VIPER17 Typical circuit

6 Typical circuit

Figure 20: Min-features flyback application

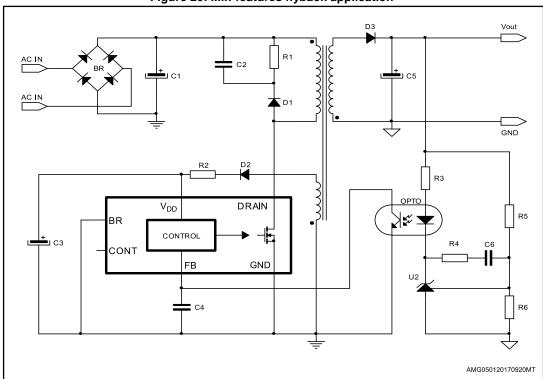
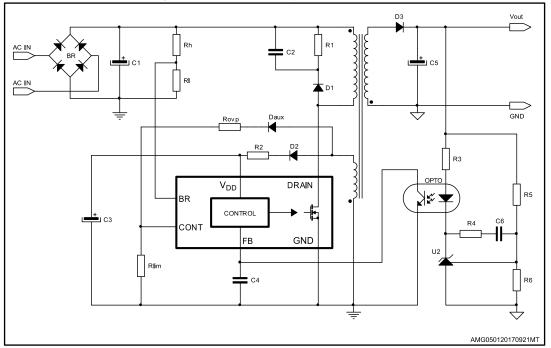


Figure 21: Full-features flyback application





7 Operation descriptions

VIPER17 is a high-performance low-voltage PWM controller chip with an 800 V, avalanche rugged power section.

The controller includes: the oscillator with jittering feature, the startup circuits with soft-start feature, the PWM logic, the current limit circuit with adjustable set point, the second over current circuit, the burst mode management, the brown-out circuit, the UVLO circuit, the auto-restart circuit and the thermal protection circuit.

The current limit set-point is set by the CONT pin. The burst mode operation guaranties high performance in the stand-by mode and helps in the energy saving norm accomplishment.

All the fault protections are built in auto restart mode with very low repetition rate to prevent IC's over heating.

7.1 Power section and gate driver

The power section is implemented with an avalanche ruggedness N-channel MOSFET, which guarantees safe operation within the specified energy rating as well as high dv/dt capability. The power section has a BV_{DSS} of 800 V min. and a typical R_{DS(on)} of 20 Ω at 25 °C.

The integrated SenseFET structure allows a virtually loss-less current sensing.

The gate driver is designed to supply a controlled gate current during both turn-on and turn-off in order to minimize common mode EMI. Under UVLO conditions an internal pull-down circuit holds the gate low in order to ensure that the Power section cannot be turned on accidentally.

7.2 High voltage startup generator

The HV current generator is supplied through the DRAIN pin and it is enabled only if the input bulk capacitor voltage is higher than V_{DRAIN_START} threshold, 80 V_{DC} typically. When the HV current generator is ON, the I_{DDch} current (3 mA typical value) is delivered to the capacitor on the V_{DD} pin. In case of auto restart mode after a fault event, the I_{DDch} current is reduced to 0.6 mA, in order to have a slow duty cycle during the restart phase.

7.3 Power-up and soft-startup

If the input voltage rises up till the device start threshold, V_{DRAIN_START}, the V_{DD} voltage begins to grow due to the I_{DDch} current (see *Table 7: "Supply section"*) coming from the internal high voltage startup circuit. If the V_{DD} voltage reaches V_{DDon} threshold (see *Table 7: "Supply section"*) the power MOSFET starts switching and the HV current generator is turned OFF. See *Figure 23: "Timing diagram: normal power-up and power-down sequences"*.

The IC is powered by the energy stored in the capacitor on the VDD pin, C_{VDD} , until when the self-supply circuit (typically an auxiliary winding of the transformer and a steering diode) develops a voltage high enough to sustain the operation.

C_{VDD} capacitor must be sized enough to avoid fast discharge and keep the needed voltage value higher than V_{DDoff} threshold. In fact, a too low capacitance value could terminate the switching operation before the controller receives any energy from the auxiliary winding.

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The following formula can be used for the V_{DD} capacitor calculation:

Equation 1

$$C_{VDD} = \frac{I_{DDch} \times t_{SSaux}}{V_{DDon} - V_{DDoff}}$$

The t_{SSaux} is the time needed for the steady state of the auxiliary voltage. This time is estimated by applicator according to the output stage configurations (transformer, output capacitances, etc.).

During the converter startup time, the drain current limitation is progressively increased to the maximum value. In this way the stress on the secondary diode is considerably reduced. It also helps to prevent transformer saturation. The soft-start time lasts 8.5 ms and the feature is implemented for every attempt of startup converter or after a fault.

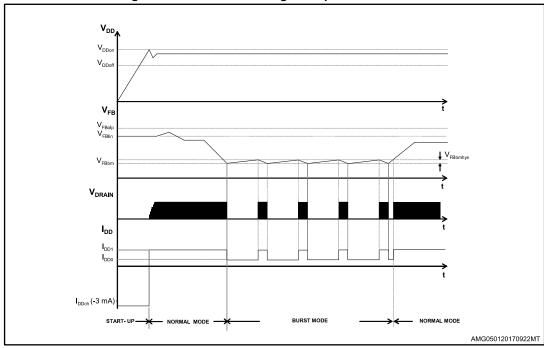


Figure 22: IDD current during startup and burst mode

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Figure 23: Timing diagram: normal power-up and power-down sequences

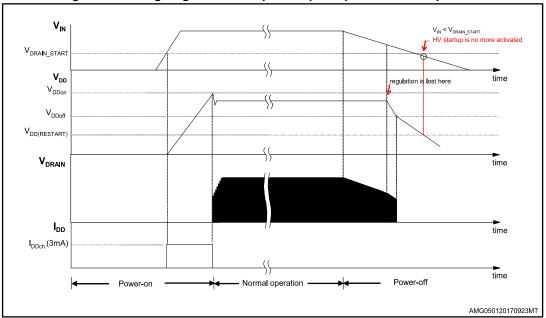
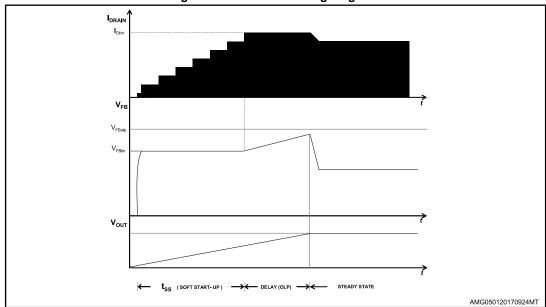


Figure 24: Soft-start: timing diagram



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7.4 Power down operation

At converter power down, the system loses regulation as soon as the input voltage is so low that the peak current limitation is reached. The V_{DD} voltage drops and when it falls below the V_{DDoff} threshold (see *Table 7: "Supply section"*) the power MOSFET is switched OFF, the energy transfers to the IC interrupted and consequently the V_{DD} voltages decreases, *Figure 23: "Timing diagram: normal power-up and power-down sequences"*. Later, if the V_{IN} is lower than V_{DRAIN_START} (see *Table 7: "Supply section"*), the startup sequence is inhibited and the power down completed. This feature is useful to prevent converter's restart attempts and ensures monotonic output voltage decay during the system power down.

7.5 Auto restart operation

If after a converter power down, the V_{IN} is higher than V_{DRAIN_START} , the startup sequence is not inhibited and will be activated only when the V_{DD} voltage drops down the $V_{DD(RESTART)}$ threshold (see *Table 7: "Supply section"*). This means that the HV startup current generator restarts the V_{DD} capacitor charging only when the V_{DD} voltage drops below $V_{DD(RESTART)}$. The scenario above described is for instance a power down because of a fault condition. After a fault condition, the charging current, I_{DDch} , is 0.6 mA (typ.) instead of the 3 mA (typ.) of a normal startup converter phase. This feature together with the low $V_{DD(RESTART)}$ threshold ensures that, after a fault, the restart attempts of the IC has a very long repetition rate and the converter works safely with extremely low power throughput. The *Figure 25: "Timing diagram: behavior after short circuit"* shows the IC behavioral after a short circuit event.

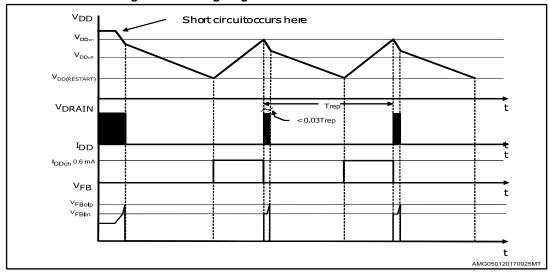


Figure 25: Timing diagram: behavior after short circuit

7.6 Oscillator

The switching frequency is internally fixed to 60 kHz or 115 kHz. In both case the switching frequency is modulated by approximately ±4 kHz (60 kHz version) or ±8 kHz (115 kHz version) at 250 Hz (typical) rate, so that the resulting spread-spectrum action distributes the energy of each harmonic of the switching frequency over a number of side-band harmonics having the same energy on the whole but smaller amplitudes.



7.7 Current mode conversion with adjustable current limit set point

The device is a current mode converter: the drain current is sensed and converted in voltage that is applied to the non inverting pin of the PWM comparator. This voltage is compared with the one on the feed-back pin through a voltage divider on cycle by cycle basis. The VIPER17 has a default current limit value, IDLIM, that the designer can adjust according the electrical specification, by the RLIM resistor connected to the CONT see Figure 16: "Current limit vs RLIM".

The CONT pin has a minimum current sunk needed to activate the I_{DLIM} adjustment: without R_{LIM} or with high R_{LIM} (i.e. 100 K Ω) the current limit is fixed to the default value (see I_{DLIM} , Table 8: "Controller section").

7.8 Overvoltage protection (OVP)

The VIPER17has integrated the logic for the monitor of the output voltage using as input signal the voltage V_{CONT} during the OFF time of the power MOSFET. This is the time when the voltage from the auxiliary winding tracks the output voltage, through the turn ratio

 $\frac{N_{AUX}}{N_{SEC}}$

The CONT pin has to be connected to the auxiliary winding through the diode D_{OVP} and the resistors R_{OVP} and R_{LIM} as shows the *Figure 27: "CONT pin configuration"*. When, during the OFF time, the voltage V_{CONT} exceeds, four consecutive times, the reference voltage V_{OVP} (see *Table 8: "Controller section"*) the overvoltage protection will stop the power MOSFET and the converter enters the auto-restart mode.

In order to bypass the noise immediately after the turn off of the power MOSFET, the voltage V_{CONT} is sampled inside a short window after the time T_{STROBE}, see *Table 8:* "Controller section" and the *Figure 26:* "OVP timing diagram". The sampled signal, if higher than V_{OVP}, trigger the internal OVP digital signal and increments the internal counter. The same counter is reset every time the signal OVP is not triggered in one oscillator cycle.

Referring to the *Figure 21: "Full-features flyback application"*, the resistors divider ratio k_{OVP} will be given by:

Equation 2

$$K_{OVP} = \frac{V_{OVP}}{\frac{N_{AUX}}{N_{SEC}} \cdot (V_{OUTOVP} + V_{DSEC}) - V_{DAUX}}$$

Equation 3

$$K_{OVP} = \frac{R_{LIM}}{R_{LIM} + R_{OVP}}$$

Where:

- Vove is the OVP threshold (see *Table 8: "Controller section"*)
- V_{OUT OVP} is the converter output voltage value to activate the OVP (set by designer)
- N_{AUX} is the auxiliary winding turns
- N_{SEC} is the secondary winding turns
- V_{DSEC} is the secondary diode forward voltage
- V_{DAUX} is the auxiliary diode forward voltage
- ROVP together RLIM make the output voltage divider

Than, fixed R_{LIM}, according to the desired I_{DLIM}, the R_{OVP} can be calculating by:

Equation 4

$$R_{OVP} = R_{LIM} \times \frac{1 - K_{OVP}}{K_{OVP}}$$

The resistor values will be such that the current sourced and sunk by the CONT pin be within the rated capability of the internal clamp.

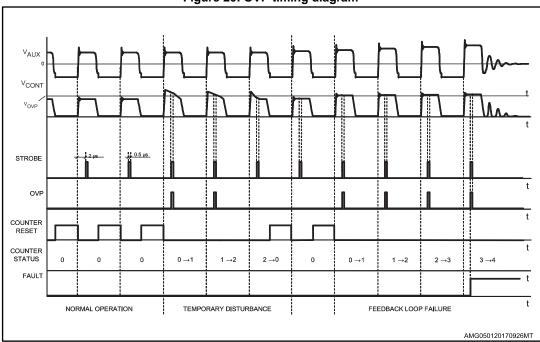


Figure 26: OVP timing diagram

7.9 About CONT pin

Referring to the *Figure 27: "CONT pin configuration"*, through the CONT pin, the below features can be implemented:

- 1. Current Limit set point
- 2. Over voltage protection on the converter output voltage

The Table 9: "CONT pin configurations" referring to the Figure 27: "CONT pin configuration", lists the external components needed to activate one or plus of the CONT pin functions.

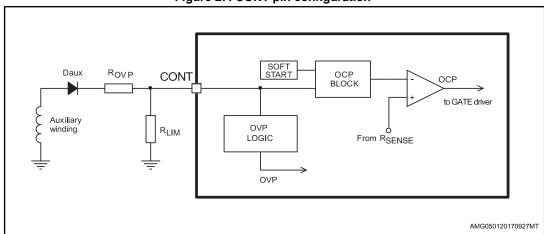


Figure 27: CONT pin configuration

Table 9: CONT pin configurations

Function / component	R _{LIM} (1)	Rove	D _{AUX}
I _{Dlim} reduction	See Figure 16: "Current limit vs RLIM"	No	No
OVP	≥ 80 KΩ See Equa		Yes
I _{Dlim} reduction + OVP	See Figure 16: "Current limit vs RLIM"	See Equation 4	Yes

Notes:

7.10 Feed-back and overload protection (OLP)

The VIPER17 is a current mode converter: the feedback pin controls the PWM operation, controls the burst mode and actives the overload protection. *Figure 28: "FB pin configuration (minimal)"* and *Figure 29: "FB pin configuration (two poles and one zero)"* show the internal current mode structure.

With the feedback pin voltage between V_{FBbm} and V_{FBlin}, see *Table 8: "Controller section"*, the drain current is sensed and converted in voltage that is applied to the non inverting pin of the PWM comparator. See *Figure 2: "Block diagram"*.

This voltage is compared with the one on the feedback pin through a voltage divider on cycle by cycle basis. When these two voltages are equal, the PWM logic orders the switch off of the power MOSFET. The drain current is always limited to IDIIM value.

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⁽¹⁾R_{LIM} has to be fixed before of R_{OVP}.

In case of overload the feedback pin increases in reaction to this event and when it goes higher than V_{FBlin}, the PWM comparator is disabled and the drain current is limited to I_{Dlim} by the OCP comparator, see *Figure 2: "Block diagram"*.

When the feedback pin voltage reaches the threshold V_{FBlin} an internal current generator starts to charge the feedback capacitor (C_{FB}) and when the feedback voltage reaches the V_{FBolp} threshold, the converter is turned off and the startup phase is activated with reduced value of I_{DDch} to 0.6 mA. See *Table 7: "Supply section"*.

During the first startup phase of the converter, after the soft-startup time, t_{SS}, the output voltage could force the feedback pin voltage to rise up to the V_{FBolp} threshold that switches off the converter itself.

To avoid this event, the appropriate feedback network has to be selected according to the output load. More the network feedback fixes the compensation loop stability. The *Figure 28: "FB pin configuration (minimal)"* and *Figure 29: "FB pin configuration (two poles and one zero)"* show the two different feedback networks.

The time from the over load detection ($V_{FB} = V_{FBlin}$) to the device shutdown ($V_{FB} = V_{FBolp}$) can be calculating by C_{FB} value (see *Figure 28: "FB pin configuration (minimal)"* and *Figure 29: "FB pin configuration (two poles and one zero)"*), using the formula:

Equation 5

$$T_{OLP} - delay = C_{FB} \times \frac{V_{FBolp} - V_{FBlin}}{3\mu A}$$

In the *Figure 28: "FB pin configuration (minimal)"*, the capacitor connected to FB pin (C_{FB}) is used as part of the circuit to compensate the feedback loop but also as element to delay the OLP shut down owing to the time needed to charge the capacitor (see *Equation 5*).

After the startup time, t_{SS} , during which the feedback voltage is fixed at V_{FBlin} , the output capacitor could not be at its nominal value and the controller interpreter this situation as an over load condition. In this case, the OLP delay helps to avoid an incorrect device shut down during the startup.

Owing to the above considerations, the OLP delay time must be long enough to by-pass the initial output voltage transient and check the over load condition only when the output voltage is in steady state. The output transient time depends from the value of the output capacitor and from the load.

When the value of the C_{FB} capacitor calculated for the loop stability is too low and cannot ensure enough OLP delay, an alternative compensation network can be used and it is showed in *Figure 29: "FB pin configuration (two poles and one zero)"*.

Using this alternative compensation network, two poles (f_{PFB}, f_{PFB1}) and one zero (f_{ZFB}) are introduced by the capacitors C_{FB} and C_{FB1} and the resistor R_{FB1}.

The capacitor C_{FB} introduces a pole (f_{PFB}) at higher frequency than f_{ZB} and f_{PFB1}. This pole is usually used to compensate the high frequency zero due to the ESR (Equivalent Series Resistor) of the output capacitance of the fly-back converter.

The mathematical expressions of these poles and zero frequency, considering the scheme in *Figure 29: " FB pin configuration (two poles and one zero)"* are reported by the equations below:

Equation 6

$$f_{ZFB} = \frac{1}{2 \cdot \pi \cdot C_{FB1} \cdot R_{FB1}}$$



Equation 7

$$f_{PFB1} = \frac{R_{FB(DYN)} + R_{FB1}}{2 \cdot \pi \cdot C_{FB} \cdot \left(R_{FB(DYN)} \cdot R_{FB1}\right)}$$

Equation 8

$$f_{PFB1} = \frac{1}{2 \cdot \pi \cdot C_{FB1} \cdot (R_{FB1} + R_{FB(DYN)})}$$

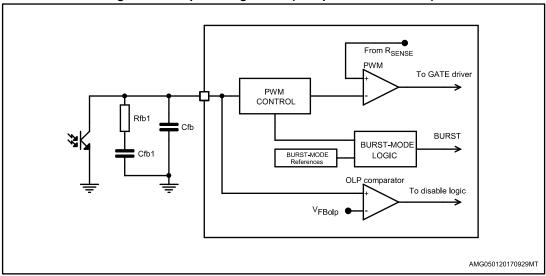
The RFB(DYN) is the dynamic resistance seen by the FB pin.

The C_{FB1} capacitor fixes the OLP delay and usually C_{FB1} results much higher than C_{FB}. The Equation 5 can be still used to calculate the OLP delay time but CFB1 has to be considered instead of CFB. Using the alternative compensation network, the designer can satisfy, in all case, the loop stability and the enough OLP delay time alike.

From sense FET To PWM Logic CONTROL BURST BURST-MODE BURST-MODE LOGIC To disable logic AMG050120170928MT

Figure 28: FB pin configuration (minimal)





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VIPER17 Operation descriptions

7.11 Burst-mode operation at no load or very light load

When the load decrease the feedback loop reacts lowering the feedback pin voltage. If it falls down the burst mode threshold, V_{FBbm}, the power MOSFET is not more allowed to be switched on. After the MOSFET stops, as a result of the feedback reaction to the energy delivery stop, the feedback pin voltage increases and exceeding the level, V_{FBbm} + V_{FBbmhys}, the power MOSFET starts switching again. The burst mode thresholds are reported on *Table 8: "Controller section"* and *Figure 30: "Burst mode timing diagram, light load management"* shows this behavior. Systems alternates period of time where power MOSFET is switching to period of time where power MOSFET is not switching; this device working mode is the burst mode. The power delivered to output during switching periods exceeds the load power demands; the excess of power is balanced from not switching period where no power is processed. The advantage of burst mode operation is an average switching frequency much lower then the normal operation working frequency, up to some hundred of hertz, minimizing all frequency related losses. During the burst-mode the drain current peak is clamped to the level, I_{D_BM}, reported on *Table 8: "Controller section"*.

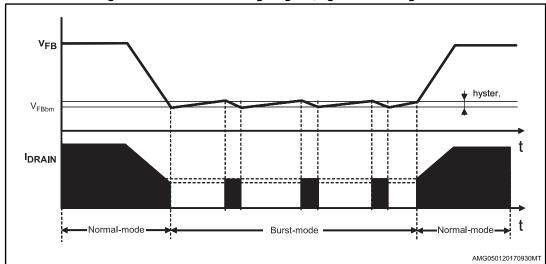


Figure 30: Burst mode timing diagram, light load management

7.12 Brown-out protection

Brown-out protection is a not-latched shutdown function activated when a condition of mains under voltage is detected. The Brown-out comparator is internally referenced to V_{BRth} threshold, see *Table 8: "Controller section"*, and disables the PWM if the voltage applied at the BR pin is below this internal reference. Under this condition the power MOSFET is turned off. Until the Brown out condition is present, the V_{DD} voltage continuously oscillates between the V_{DDn} and the UVLO thresholds, as shown in the timing diagram of *Figure 31: "Brown-out protection: BR external setting and timing diagram"*. A voltage hysteresis is present to improve the noise immunity.

The switching operation is restarted as the voltage on the pin is above the reference plus the before said voltage hysteresis. See *Figure 5: "Brown out threshold test circuit"*.

The Brown-out comparator is provided also with a current hysteresis, I_{BRhyst} . The designer has to set the rectified input voltage above which the power MOSFET starts switching after brown out event, V_{INon} , and the rectified input voltage below which the power MOSFET is switched off, V_{INoff} . Thanks to the I_{BRhyst} , see *Table 8: "Controller section"*, these two thresholds can be set separately.



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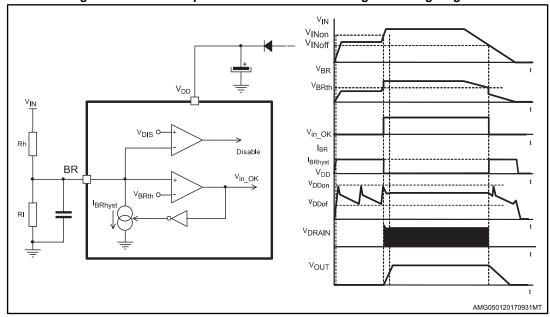


Figure 31: Brown-out protection: BR external setting and timing diagram

Fixed the V_{INon} and the V_{INoff} levels, with reference to *Figure 31: "Brown-out protection: BR external setting and timing diagram"*, the following relationships can be established for the calculation of the resistors R_H and R_L :

Equation 9

$$R_L = \frac{V_{BRhyst}}{I_{BRhyst}} + \frac{V_{INon} - V_{INoff} - V_{BRhyst}}{V_{INoff} - V_{BRth}} \times \frac{V_{BRth}}{I_{BRhyst}}$$

Equation 10

$$R_{H} = \frac{V_{INon} - V_{INoff} - V_{BRhyst}}{I_{BRhyst}} \times \frac{R_{L}}{R_{L} + \frac{V_{BRhyst}}{I_{RPhyst}}}$$

For a proper operation of this function, $V_{\text{IN on}}$ must be less than the peak voltage at minimum mains and $V_{\text{IN off}}$ less than the minimum voltage on the input bulk capacitor at minimum mains and maximum load.

The BR pin is a high impedance input connected to high value resistors, thus it is prone to pick up noise, which might alter the OFF threshold when the converter operates or gives origin to undesired switch-off of the device during ESD tests.

It is possible to bypass the pin to ground with a small film capacitor (e.g. 1-10 nF) to prevent any malfunctioning of this kind.

If the brown-out function is not used the BR pin has to be connected to GND, ensuring that the voltage is lower than the minimum of V_{DIS} threshold (50 mV, see *Table 8: "Controller section"*). In order to enable the brown-out function the BR pin voltage has to be higher than the maximum of V_{DIS} threshold (150 mV, see *Table 8: "Controller section"*).

7.13 2nd level overcurrent protection and hiccup mode

The VIPER17 is protected against short circuit of the secondary rectifier, short circuit on the secondary winding or a hard-saturation of fly-back transformer. Such as anomalous condition is invoked when the drain current exceed the threshold I_{DMAX} (see *Table 8: "Controller section"*).

To distinguish a real malfunction from a disturbance (e.g. induced during ESD tests) a "warning state" is entered after the first signal trip. If in the subsequent switching cycle the signal is not tripped, a temporary disturbance is assumed and the protection logic will be reset in its idle state; otherwise if the I_{DMAX} threshold is exceeded for two consecutive switching cycles a real malfunction is assumed and the power MOSFET is turned OFF.

The shutdown condition is latched as long as the device is supplied. While it is disabled, no energy is transferred from the auxiliary winding; hence the voltage on the V_{DD} capacitor decays till the V_{DD} under voltage threshold (V_{DDoff}), which clears the latch.

The startup HV current generator is still off, until V_{DD} voltage goes below its restart voltage, $V_{DD(RESTART)}$. After this condition the V_{DD} capacitor is charged again by 600 μ A current, and the converter switching restarts if the V_{DDon} occurs. If the fault condition is not removed the device enters in auto-restart mode. This behavioral results in a low-frequency intermittent operation (Hiccup-mode operation), with very low stress on the power circuit. See the timing diagram of *Figure 32: "Hiccup-mode OCP: timing diagram"*.

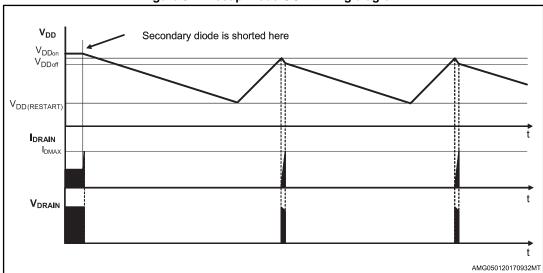


Figure 32: Hiccup-mode OCP: timing diagram

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Package information VIPER17

8 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

8.1 SO16 narrow package information

SEATING PLANE Α2 E1 Α1 222

Figure 33: SO16 narrow package outline

Table 10: SO16 narrow mechanical data

Dim.	mm					
Dilli.	Min.	Тур.	Max.			
А			1.75			
A1	0.1		0.25			
A2	1.25					
b	0.31		0.51			
С	0.17		0.25			
D	9.8	9.9	10			
E	5.8	6	6.2			
E1	3.8	3.9	4			
е		1.27				
h	0.25		0.5			
L	0.4		1.27			
k	0		8			
ccc			0.1			

Package information VIPER17

8.2 DIP-7 package information

Figure 34: DIP-7 package outline

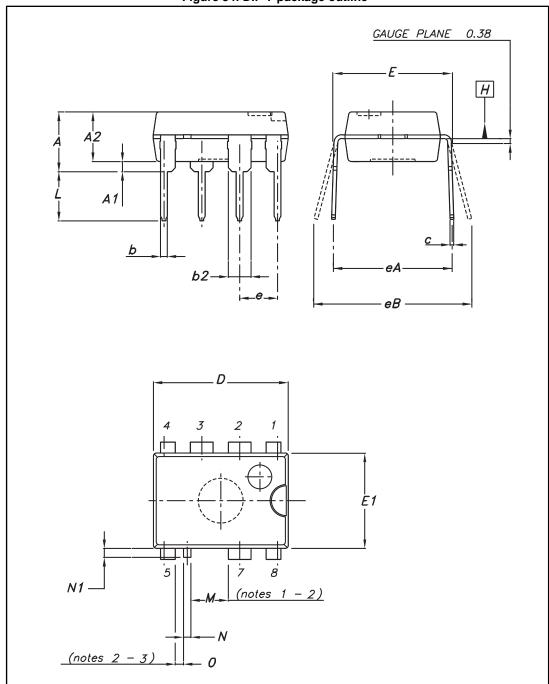


Table 11: DIP-7 package mechanical data

Dim.	mm			Netes
	Min.	Тур.	Max.	Notes
A			5.33	
A1	0.38			
A2	2.92	3.30	4.95	
b	0.36	0.46	0.56	
b2	1.14	1.52	1.78	
С	0.20	0.25	0.36	
D	9.02	9.27	10.16	
E	7.62	7.87	8.26	
E1	6.10	6.35	7.11	
е		2.54		
eA		7.62		
eB			10.92	
L	2.92	3.30	3.81	
M ⁽¹⁾⁽²⁾		2.508		6 - 8
N	0.40	0.50	0.60	
N1			0.60	
O ⁽²⁾⁽³⁾		0.548		7 - 8

Notes:

General package performance

- The leads size is comprehensive of the thickness of the leads finishing material.
- Dimensions do not include mold protrusion, not to exceed 0,25 mm in total (both side).
- Package outline exclusive of metal burrs dimensions.
- Datum plane "H" coincident with the bottom of lead, where lead exits body.
- Ref. POA MOTHER doc. 0037880.

⁽¹⁾ Creepage distance > 800 V.

 $^{^{\}rm (2)}$ Creepage distance as shown in the 664-1 CEI / IEC standard.

⁽³⁾ Creepage distance 250 V.

Revision history VIPER17

9 Revision history

Table 12: Document revision history

Date	Revision	Changes	
14-Feb-2008	1	Initial release	
19-Feb-2008	2	Updated: Figure 1 on page 1, Figure 3 on page 4	
21-Jul-2008	3	Added new SO16 package	
30-Sep-2008	4	Updated Equation 9, Equation 10	
16-Jan-2009	5	Updated Chapter 7.13 on page 27	
20-Jul-2009	6	Updated application paragraph in coverpage and <i>Table 8 on page</i> 8	
14-Jun-2010	7	Updated Figure 3 on page 4 and Table 3 on page 4	
23-Jul-2013	8	Updated <i>Table 8: Controller section</i> . Minor text changes.	
30-Aug-2013	9	Modified the footnote in Table 8: Controller section.	
20-May-2014	10	Modified the title and the features in cover page. Updated Section 3: Pin settings, Section 4.1: Maximum ratings, Section 4.3: Electrical characteristics. Minor text changes.	
16-Feb-2017	11	Updated Table 5: "Thermal data", Table 7: "Supply section " and Table 8: "Controller section ". Minor text changes.	

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